

Product Highlight

- Dual data-rate of I.25Gbps/I.063Gbps operation
- 1490nm DFB laser and PIN photodetector for 20km transmission
- Compliant with SFP
 MSA and SFF-8472 with
 simplex LC or SC
 receptacle
- Digital Diagnostic Monitoring:
 - Internal Calibration or
 - External Calibration
- Compatible with SONET OC-24-LR-I
- Compatible with RoHS
- +3.3V single power supply
- Operating case temperature range of
 - 0°C to +70°C (Commercial) or
 - -40°C to +85°C (Industrial)

1.25Gbps SFP Bi-Directional Transceiver, 20km Reach 1490nm TX/1310 nm RX

XSB431-20xx

Applications

- o Gigabit Ethernet
- o Fiber Channel
- Switch to Switch interface
- Switched backplane applications
- o Router/Server interface
- Other optical transmission systems

Description

The SFP-BIDI transceivers are high performance, cost effective modules supporting dual data-rate of 1.25Gbps/1.0625Gbps and 20km transmission distance with SMF.

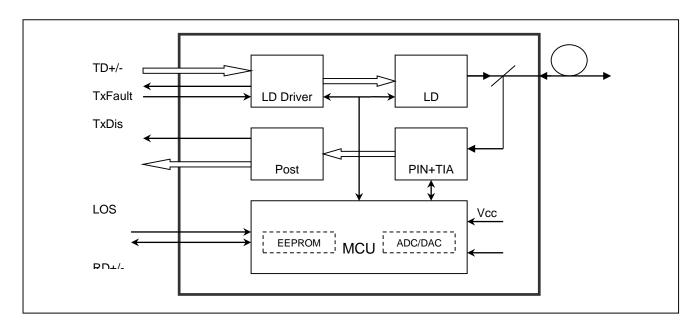
The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a transimpedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.





Module Block Diagram



Absolute Maximum Ratings

P arameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

Recommended Operating Conditions

Parameter Parameter		Symbol	Min	Typical	Max	Unit	
Operating	Case	Commercial	Tc	0		+70	°C
Temperatu	ıre	Industrial	10	-40		+85	°C
Power Supply Voltage		Vcc	3.13	3.3	3.47	٧	
Power Supply Current		lcc			300	mA	
Data Gigabit Ethernet				1.25		CI	
Rate Fiber Channel				1.063		Gbps	

Optical and Electrical Characteristics

	Parameter	Symbol	Min	Typical	Max	Unit	Notes	
	Transmitter							
Centre V	Centre Wavelength		1470	1490	1510	nm		
Spectral V	Vidth (-20dB)	Δλ			I	nm		
Side Mod	e Suppression Ratio	SMSR	30			dB		
Average (Output Power	Pout	-9		-3	dBm	I	
Extinction	n Ratio	ER	9			dB		
Optical R	ise/Fall Time (20%~80%)	t _r /t _f			0.26	ns		
Data Inpu	t Swing Differential	V _{IN}	400		1800	mV	2	
Input Diff	erential Impedance	Z _{IN}	90	100	110	Ω		
TX	Disable		2.0		Vcc	٧		
Disable	Enable		0		0.8	٧		
TX	Fault		2.0		Vcc	٧		
Fault	Normal		0		0.8	٧		
		Re	ceiver					
Centre Wavelength		λc	1260		1360	nm		
Receiver	Sensitivity				-23	dBm	3	
Receiver	Overload		-3			dBm	3	
LOS De-A	LOS De-Assert				-24	dBm		
LOS Assert		LOSA	-35			dBm		
LOS Hysteresis			1		4	dB		
Data Out	Data Output Swing Differential		400		1800	mV	4	
LOS		High	2.0		Vcc	٧		
103	LOS				8.0	٧		

Notes:

- I. The optical power is launched into SMF.
- 2. PECL input, internally AC-coupled and terminated.
- 3. Measured with a PRBS 2^7 -1 test pattern @1250Mbps, BER $\leq 1 \times 10^{-12}$.
- 4. Internally AC-coupled.

Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			I	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock			400	KHz
MOD_DEF (0:2)-High	V_{H}	2		Vcc	٧
MOD_DEF (0:2)-Low	V_{L}			0.8	٧

Diagnostics Specification

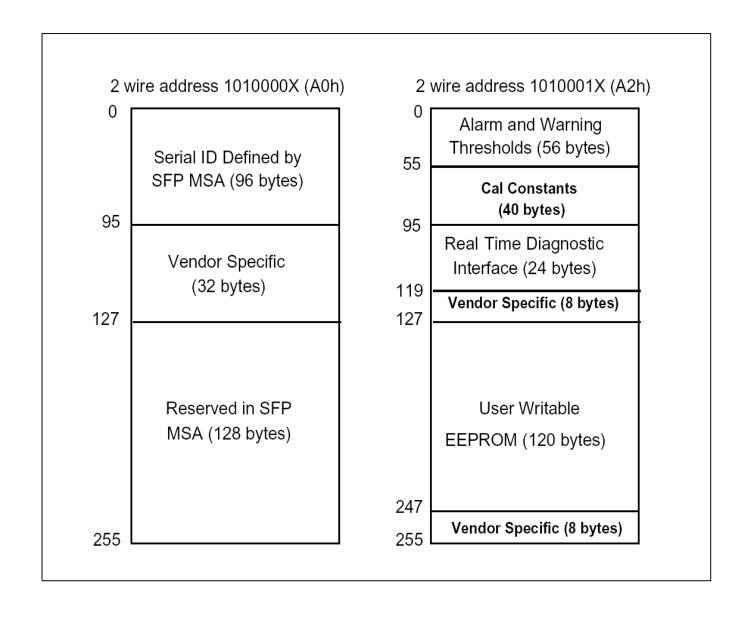
Parameter	Range	Unit	Accuracy	Calibration	
Temperature	0 to +70	°C	±3°C	Internal / External	
remperature	-40 to +85	C	±3 C	internar/Externar	
Voltage	3.0 to 3.6	٧	±3%	Internal / External	
Bias Current	0 to 100	mA	±10%	Internal / External	
TX Power	-9 to -3	dBm	±3dB	Internal / External	
RX Power	-23 to -3	dBm	±3dB	Internal / External	

Digital Diagnostic Memory Map

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

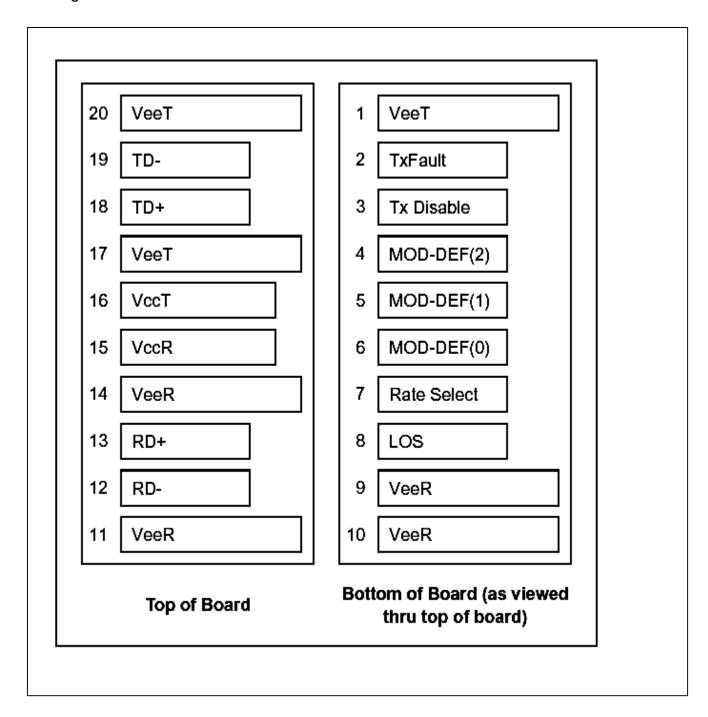
The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



Pin Definitions

Pin Diagram



Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
I	V_{EET}	Transmitter Ground	I	
2	TX FAULT	Transmitter Fault Indication	3	Note I
3	TX DISABLE	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(I)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	V_{EER}	Receiver ground	I	
10	V _{EER}	Receiver ground	I	
11	V_{EER}	Receiver ground	I	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	V _{EER}	Receiver ground	I	
15	V_{CCR}	Receiver Power Supply	2	
16	V_{CCT}	Transmitter Power Supply	2	
17	V_{EET}	Transmitter Ground	I	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	V _{EET}	Transmitter Ground	I	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- I) TX Fault is an open collector output, which should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7k\sim10k\Omega$ resistor. Its states are:

Low (0 to 0.8V): Transmitter on (>0.8V, < 2.0V): Undefined

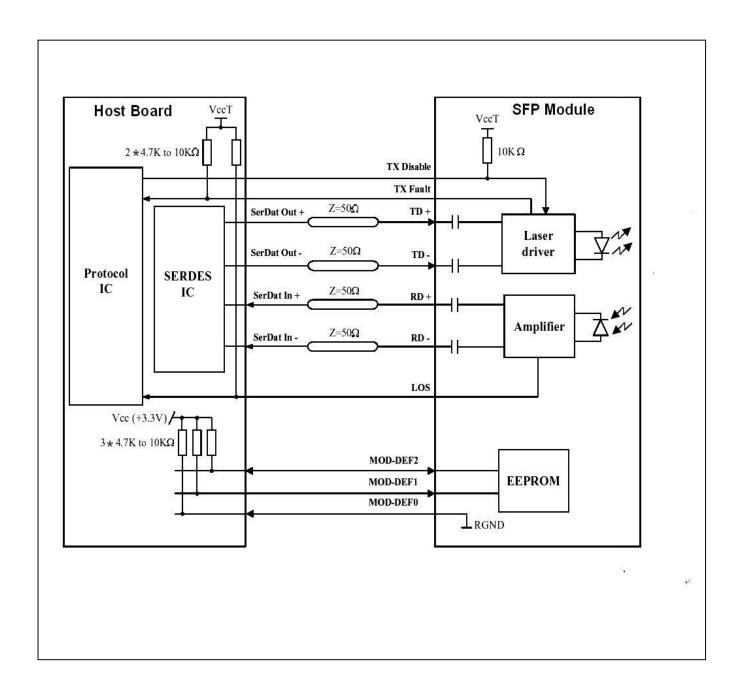
High (2.0 to 3.465V): Transmitter Disabled Open: Transmitter Disabled

- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.
 - Mod-Def 0 is grounded by the module to indicate that the module is present
 - Mod-Def I is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

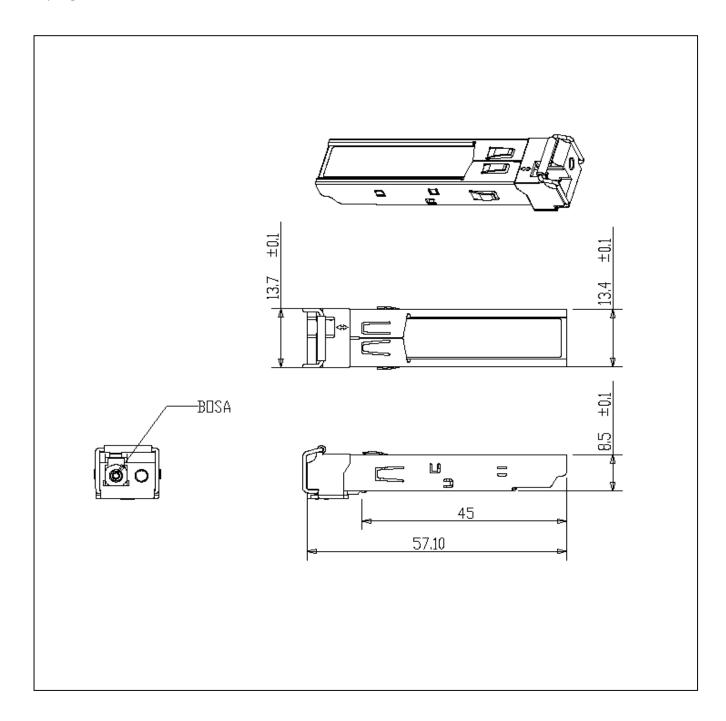
- 4) LOS is an open collector output, which should be pulled up with a $4.7k\sim10k\Omega$ resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

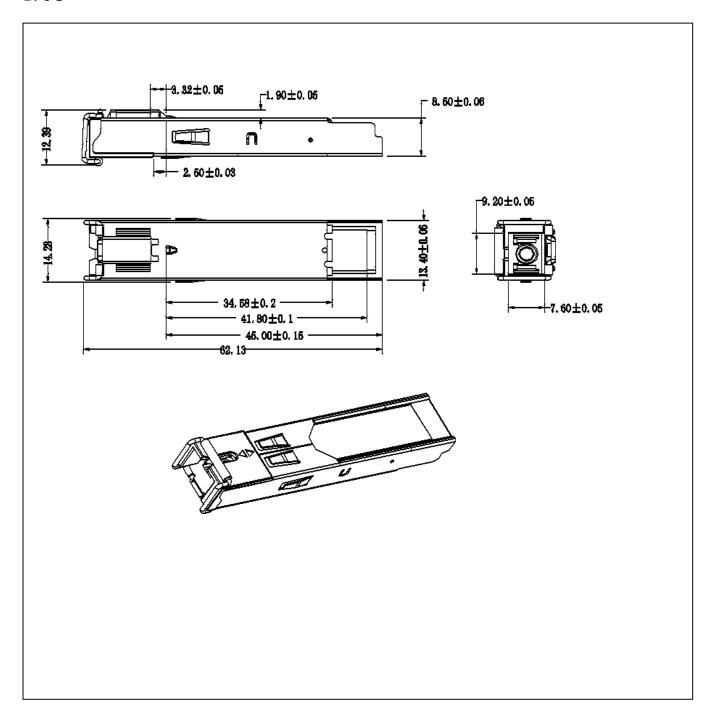
Recommended Interface Circuit



Mechanical Dimensions

A. LC





Regulatory Compliance

XENYA SFP-BIDI transceiver is designed to be Class I Laser safety compliant and is certified per the following standards:

Feature	Agency	Standard	Certificate / Comments
Laser Safety	FDA	CDRH 21 CFR 1040 and Laser Notice No. 50	1120289-000
Product Safety	BST	EN 60825-1 : 2007 EN 60825-2 : 2004 EN 60950-1 : 2006	BT0905142009
Environmental protection	SGS	RoHS Directive 2002/95/EC	GZ0902008347/CHEM
EMC	WALTEK	EN 55022:2006+A1:2007 EN 55024:1998+A1+A2:2003 -	WT10093768-D-E-E

Ordering information

Part Number	Product Description
XSB431-20SN	1490 nm, 1.25 Gbps, SC, 20 km, 0°C~+70°C
XSB431-20SY	1490 nm, 1.25 Gbps, SC, 20 km, 0°C~+70°C, With Digital Diagnostic Monitoring
XSB431-20SL	1490 nm, 1.25 Gbps, SC, 20 km, -40°C~+85°C
XSB431-20SM	1490 nm, 1.25 Gbps, SC, 20 km, -40°C~+85°C, With Digital Diagnostic Monitoring
XSB431-20LN	1490 nm, 1.25 Gbps, LC, 20 km, 0°C~+70°C
XSB431-20LY	1490 nm, 1.25 Gbps, LC, 20 km, 0°C~+70°C, With Digital Diagnostic Monitoring
XSB431-20LL	1490 nm, 1.25 Gbps, LC, 20 km, -40°C~+85°C
XSB431-20LM	1490 nm, 1.25 Gbps, LC, 20 km, -40°C~+85°C, With Digital Diagnostic Monitoring

Notice. Please specify any compatibility requirements at time of ordering. Standard MSA compatible pluggable components may not work or some function of these components may not be available in devices that require customized compatible devices. Pluggable components compatible with one type of communications equipment may not work in other type of communications equipment.

References

- I. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA), September 2000.
- 2. Telcordia GR-253and ITU-T G.957 Specifications.

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by XENYA before they become applicable to any particular order or contract. In accordance with the XENYA policy of continuous improvement specifications may change without notice.

The publication of information in this data sheet does not imply freedom from patent or other protective rights of XENYA or others. Further details are available from any XENYA sales representative.

E-mail: info@xenya.si
Web: www.xenya.si